


FIG. 2C



A cross-sectional view of a device structure. It consists of three distinct layers. The bottom layer is a solid white rectangle, labeled 101 on its right side. Above it is a middle layer with a diagonal hatching pattern (lines sloping down from left to right), labeled 102 on its right side. The top layer is a thin layer with a cross-hatching pattern, labeled 104 on its right side.

FIG. 2D

A cross-sectional view of a device. It consists of a large rectangular substrate labeled 101. On top of the substrate is a thin layer labeled 102. Five rectangular features, each labeled 104, are positioned on top of the thin layer 102. The features 104 are spaced apart and have a diagonal hatching pattern.

FIG. 1 is a schematic diagram of a circular substrate 101. A grid of square elements 110 is arranged on the substrate in a diamond pattern, with the elements being more densely packed in the center and tapering off towards the edges. The substrate is labeled 101 and the grid elements are labeled 110.

Figure 1 is a schematic diagram of a rectangular structure divided into two vertical sections. The left section is labeled 111 and the right section is labeled 112.

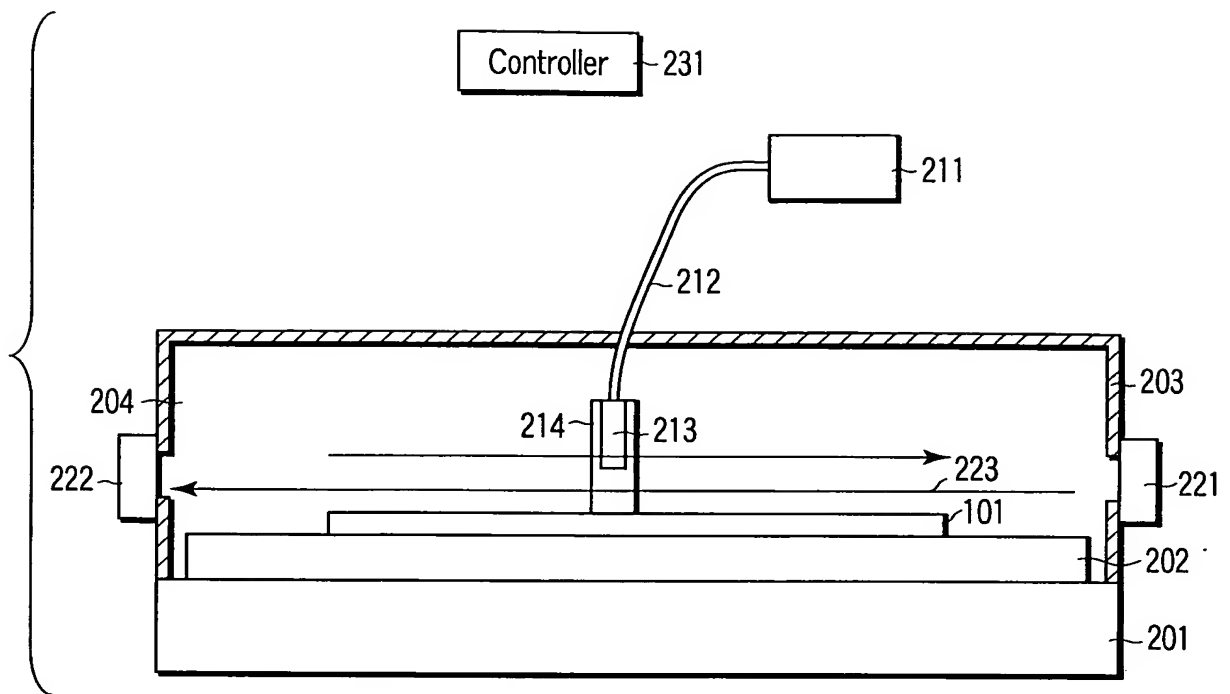


FIG. 4

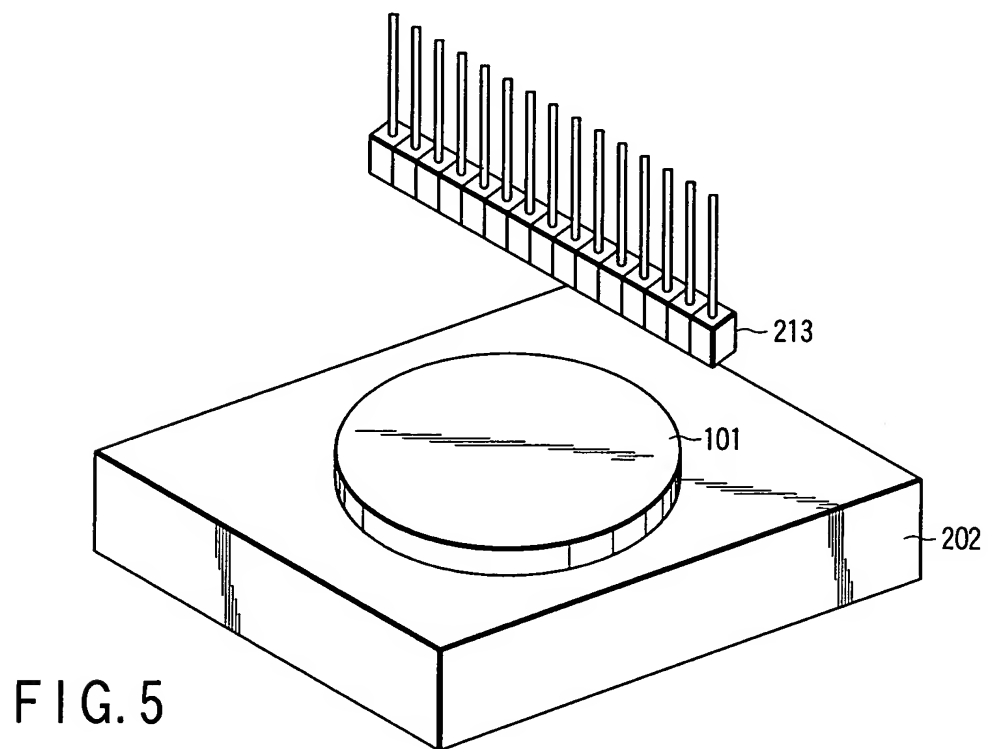


FIG. 5

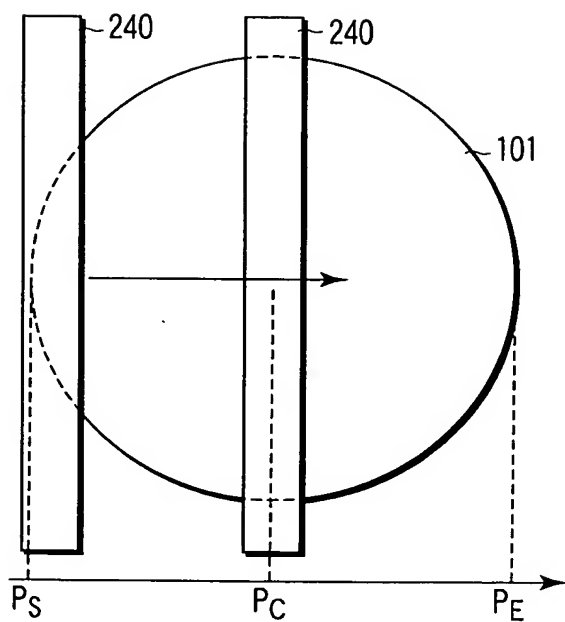


FIG. 6

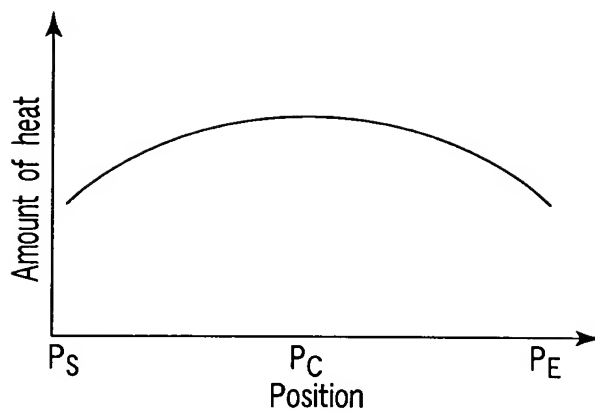


FIG. 7

FIG. 8A

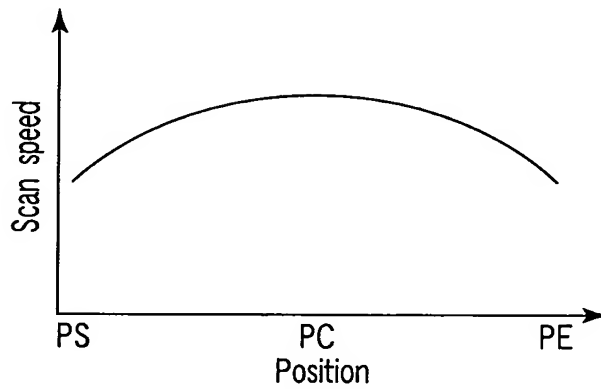
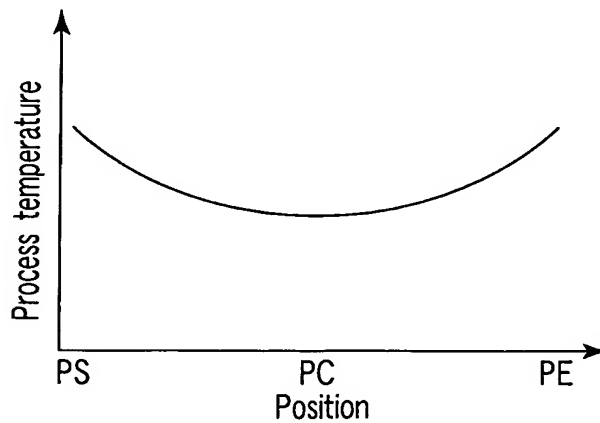


FIG. 8B



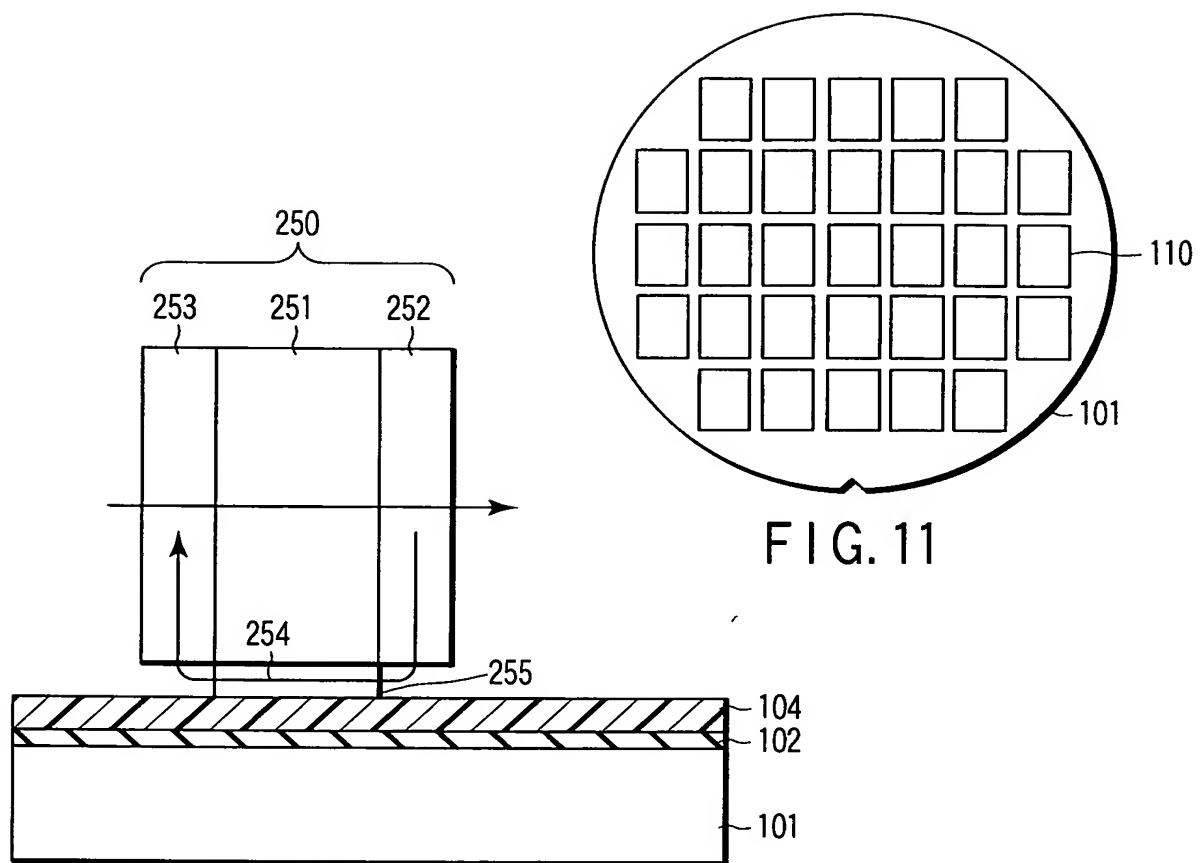


FIG. 9

FIG. 11

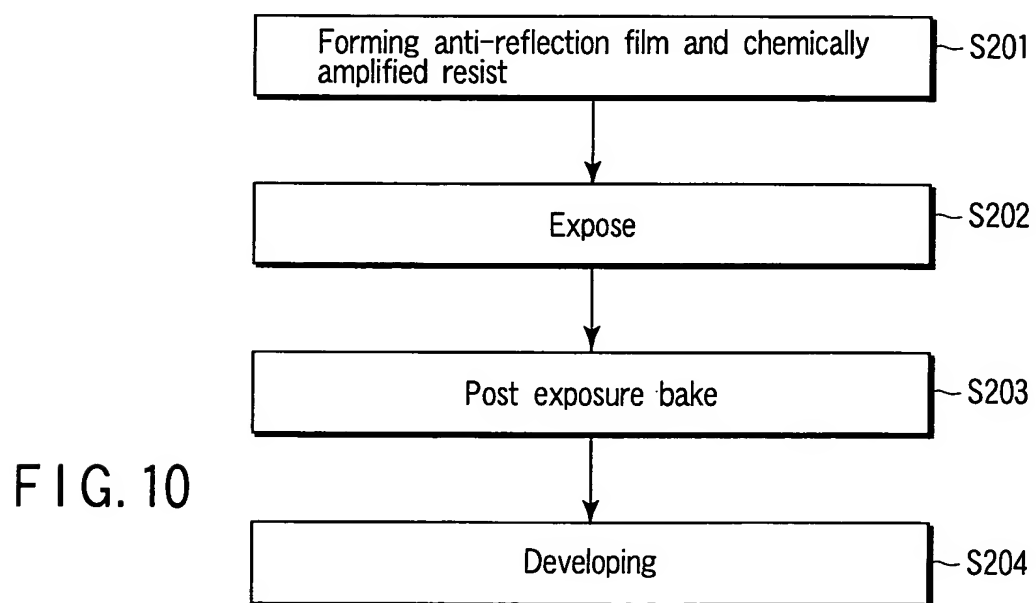


FIG. 10

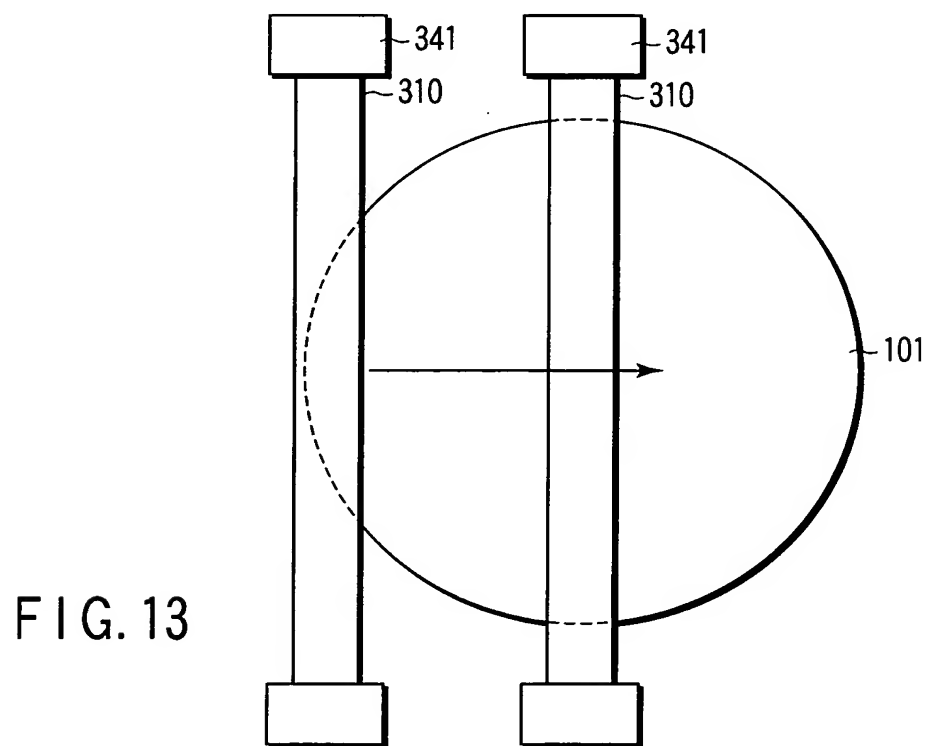
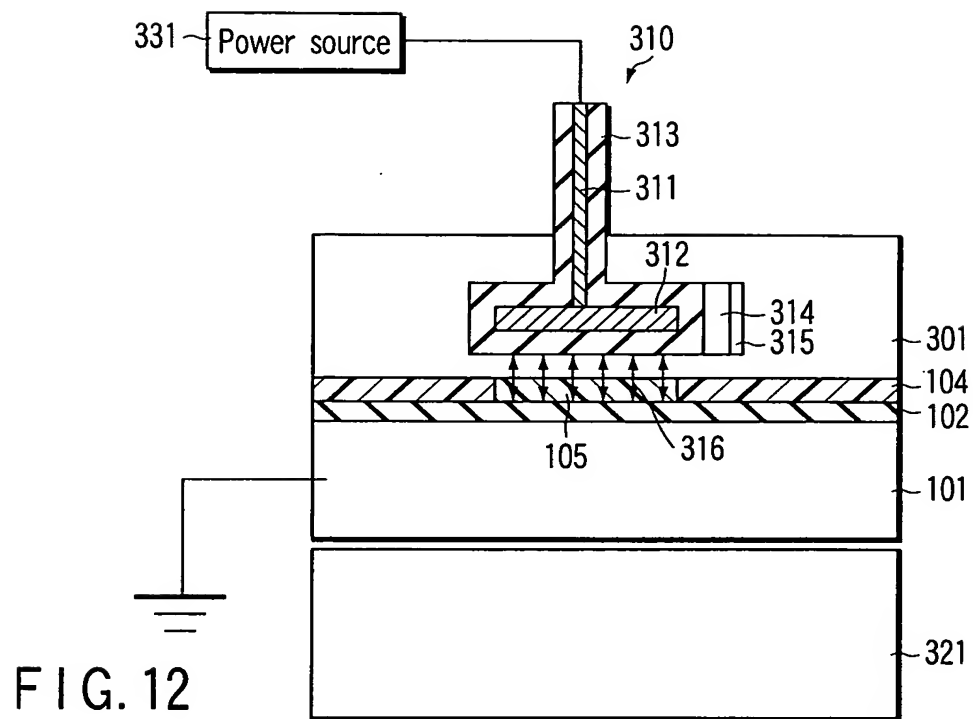


FIG. 14

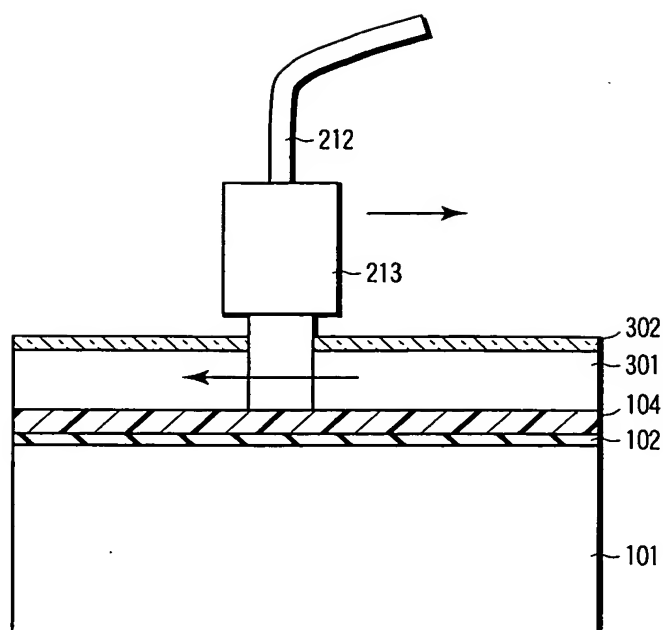


FIG. 15

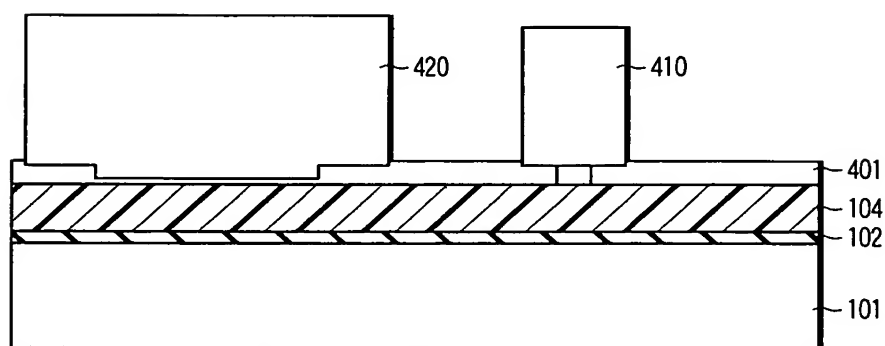
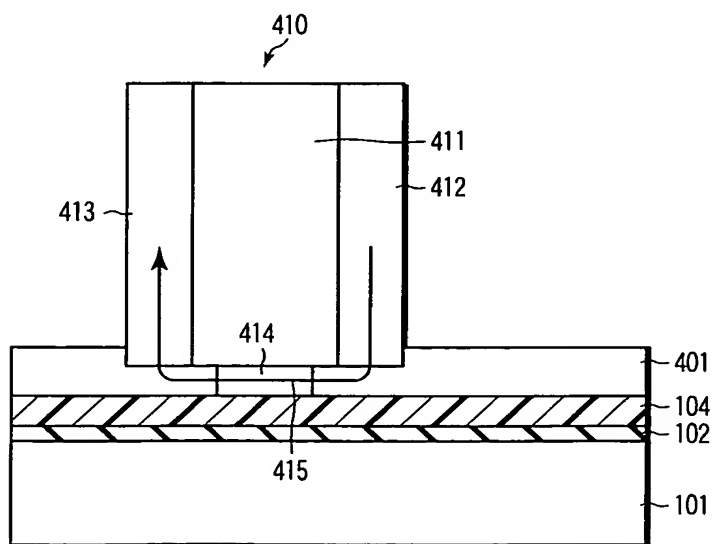


FIG. 16



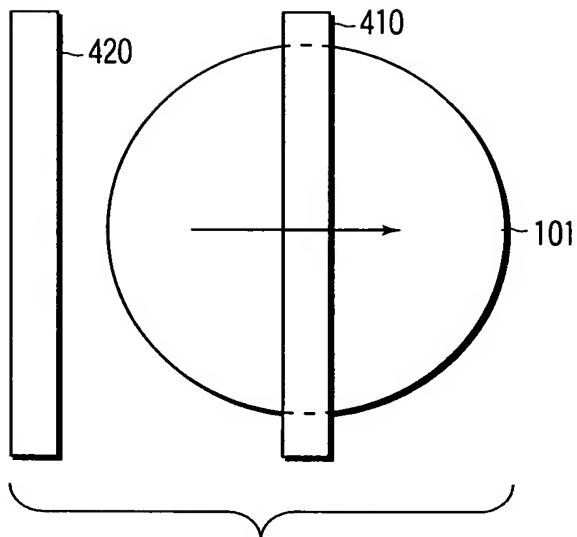


FIG. 17A

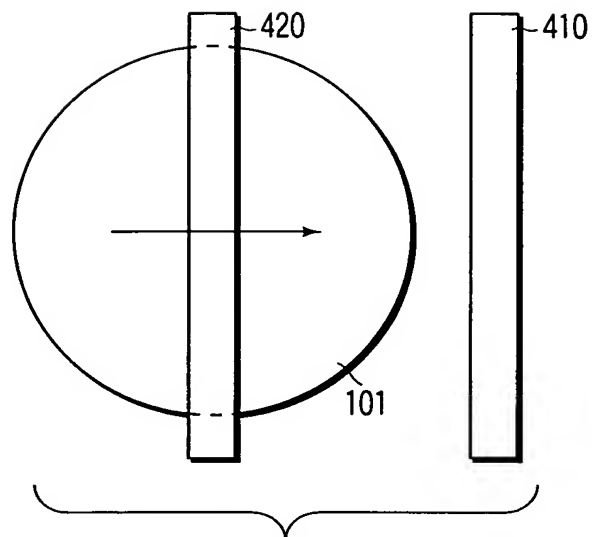


FIG. 17B

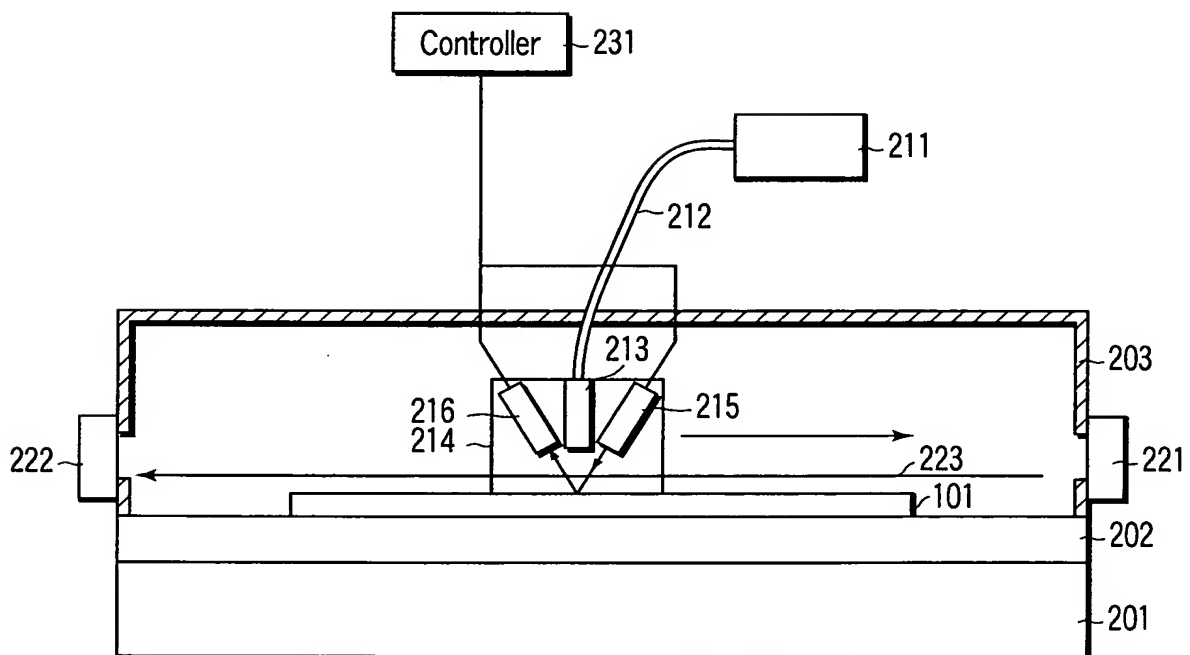


FIG. 18



FIG. 19

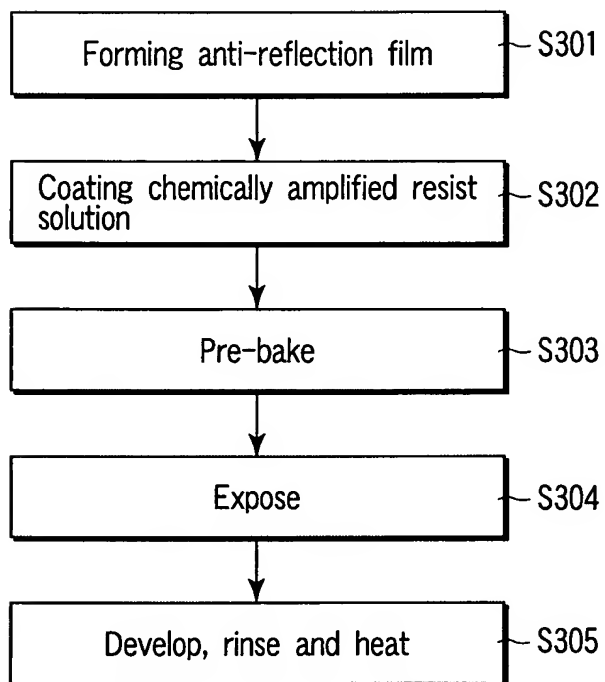
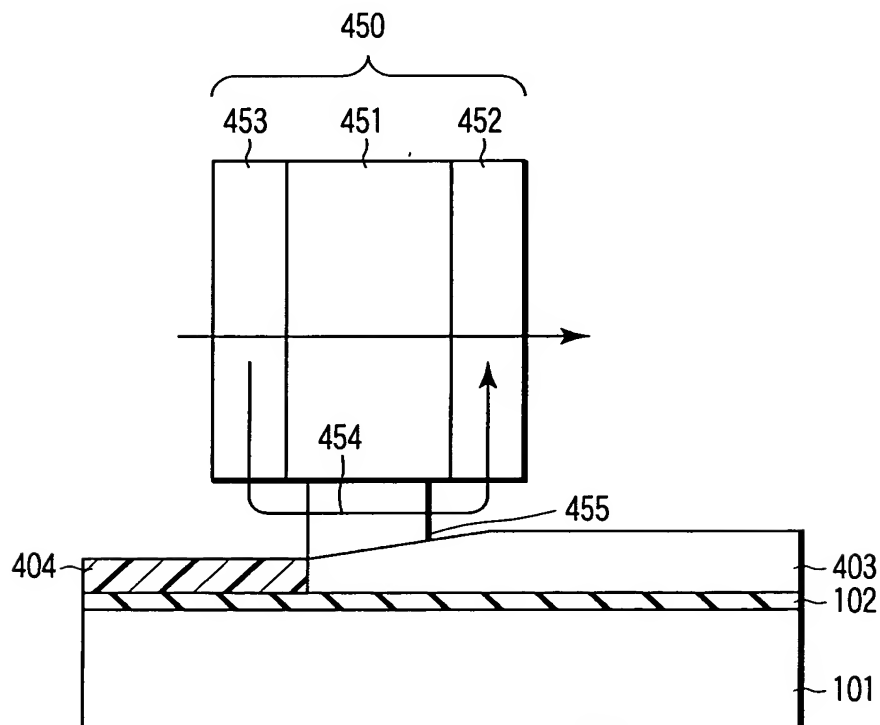


FIG. 21



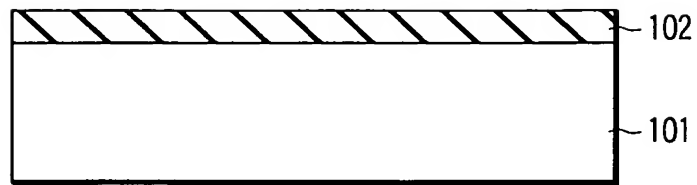


FIG. 20A

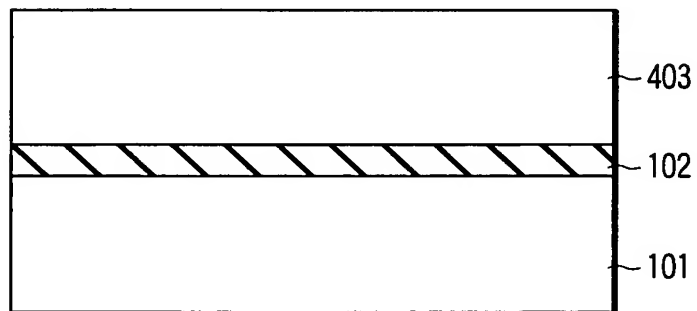


FIG. 20B

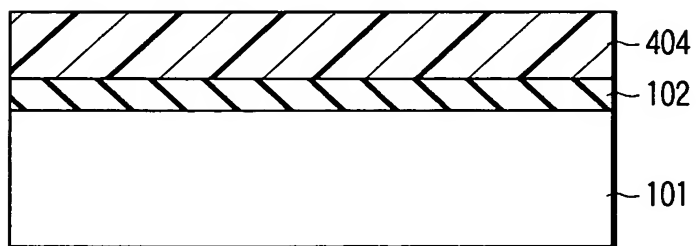


FIG. 20C

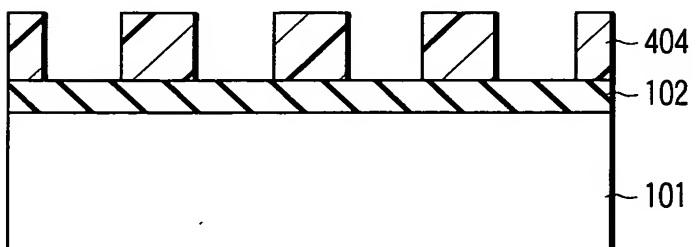


FIG. 20D